## **Power MOSFET**

## 40 V, 17.0 mΩ, 27 A, Dual N-Channel

#### **Features**

- Small Footprint (5 x 6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVMFD5C478NWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	40	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		T <sub>C</sub> = 25°C	I <sub>D</sub>	27	Α
Current R <sub>θJC</sub> (Notes 1, 2, 3, 4)	Steady State	T <sub>C</sub> = 100°C		19	
Power Dissipation		T <sub>C</sub> = 25°C	$P_{D}$	23	W
R <sub>θJC</sub> (Notes 1, 2, 3)		T <sub>C</sub> = 100°C		12	
Continuous Drain		T <sub>A</sub> = 25°C	I <sub>D</sub>	9.8	Α
Current R <sub>0JA</sub> (Notes 1 & 3, 4)	Steady State	T <sub>A</sub> = 100°C		6.9	
Power Dissipation		T <sub>A</sub> = 25°C	$P_{D}$	3.1	W
R <sub>θJA</sub> (Notes 1, 3)		T <sub>A</sub> = 100°C	1	1.5	
Pulsed Drain Current	$T_A = 25^{\circ}C$ , $t_p = 10 \mu s$		I <sub>DM</sub>	90	Α
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Source Current (Body Diode)			I <sub>S</sub>	19	Α
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 1.4 A)			E <sub>AS</sub>	48	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 3)	$R_{\theta JC}$	6.5	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	48.8	

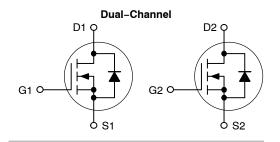
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi  $(\Psi)$  is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

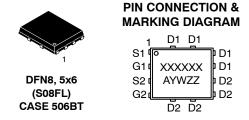


### ON Semiconductor®

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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
40 V	17.0 mΩ @ 10 V	27 A





XXXXXX = 5C478N (NVMFD5C478N) or 478NWF (NVMFD5C478NWF)

A = Assembly Location

′ = Year

ZZ = Lot TraceabilityWW = Work WeekPb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 5 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 40 V	T <sub>J</sub> = 25°C			10	μΑ
			T <sub>J</sub> = 125°C			250	1
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{G}$	iS = 20 V			100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_{D}$	) = 20 μΑ	2.5		3.5	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>I</sub>	<sub>O</sub> = 7.5 A		14	17	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 7.5 A			2		S
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>iss</sub>				325		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V, f} = V_{DS} = 2$	1.0 MHz, 5 V		165		
Reverse Transfer Capacitance	C <sub>rss</sub>	VDS - 25 V			10		1
Total Gate Charge	Q <sub>G(TOT)</sub>				6.3		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 32 V, I <sub>D</sub> = 7.5 A			1.3		nC
Gate-to-Source Charge	$Q_{GS}$				2.0		
Gate-to-Drain Charge	$Q_{GD}$				1.2		
SWITCHING CHARACTERISTICS (No	te 6)						
Turn-On Delay Time	t <sub>d(on)</sub>				7		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 10 V, V <sub>E</sub>	ns = 32 V,		13		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D = 7.5 \text{ A}, R_G = 1 \Omega$			14		
Fall Time	t <sub>f</sub>				4.5		
DRAIN-SOURCE DIODE CHARACTER	RISTICS						
Forward Diode Voltage	$V_{SD}$	V <sub>GS</sub> = 0 V,	T <sub>J</sub> = 25°C		0.84	1.2	V
		I <sub>S</sub> = 7.5 A	T <sub>J</sub> = 125°C		0.72		7
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V, } dl_S/dt = 100 \text{ A/}\mu\text{s,}$ $l_S = 7.5 \text{ A}$			18		ns
Charge Time	t <sub>a</sub>				7.0		
Discharge Time	t <sub>b</sub>				11		
Reverse Recovery Charge	Q <sub>RR</sub>				6		nC

<sup>5.</sup> Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**

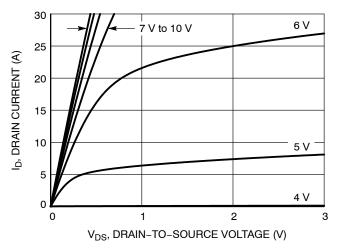


Figure 1. On-Region Characteristics

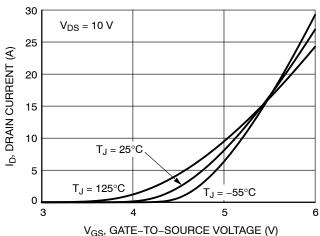


Figure 2. Transfer Characteristics

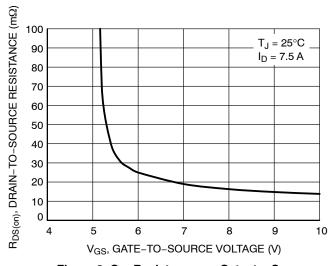


Figure 3. On-Resistance vs. Gate-to-Source Voltage

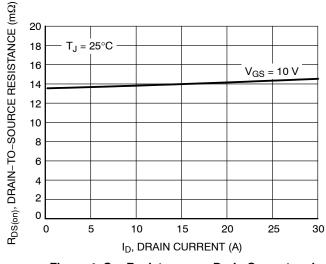


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

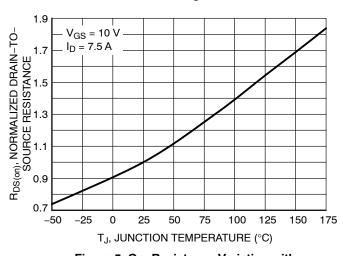


Figure 5. On–Resistance Variation with Temperature

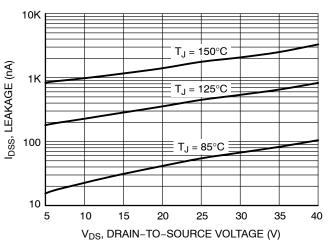


Figure 6. Drain-to-Source Leakage Current vs. Voltage

#### **TYPICAL CHARACTERISTICS**

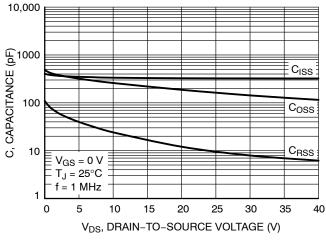


Figure 7. Capacitance Variation

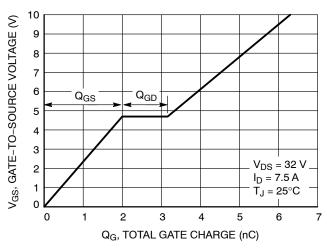
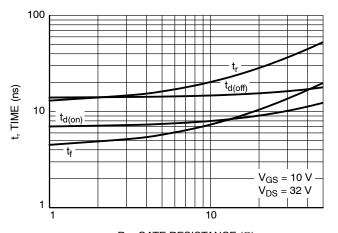


Figure 8. Gate-to-Source Voltage vs. Total Charge



 $R_G$ , GATE RESISTANCE ( $\Omega$ )

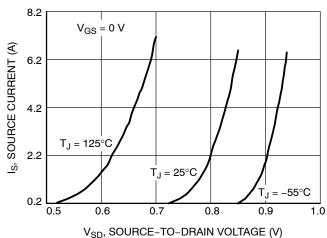


Figure 10. Diode Forward Voltage vs. Current



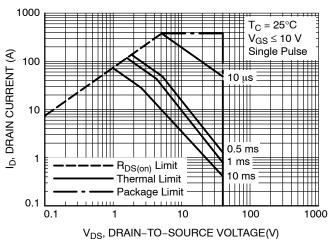


Figure 11. Maximum Rated Forward Biased Safe Operating Area

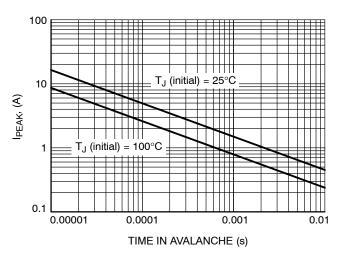


Figure 12. I<sub>PEAK</sub> vs. Time in Avalanche

#### **TYPICAL CHARACTERISTICS**

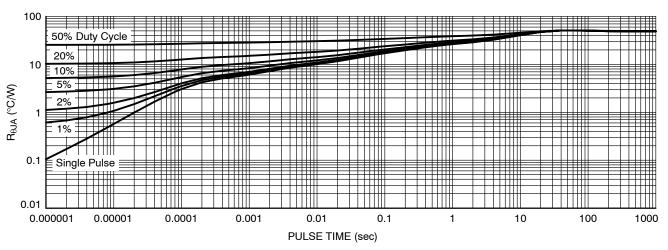


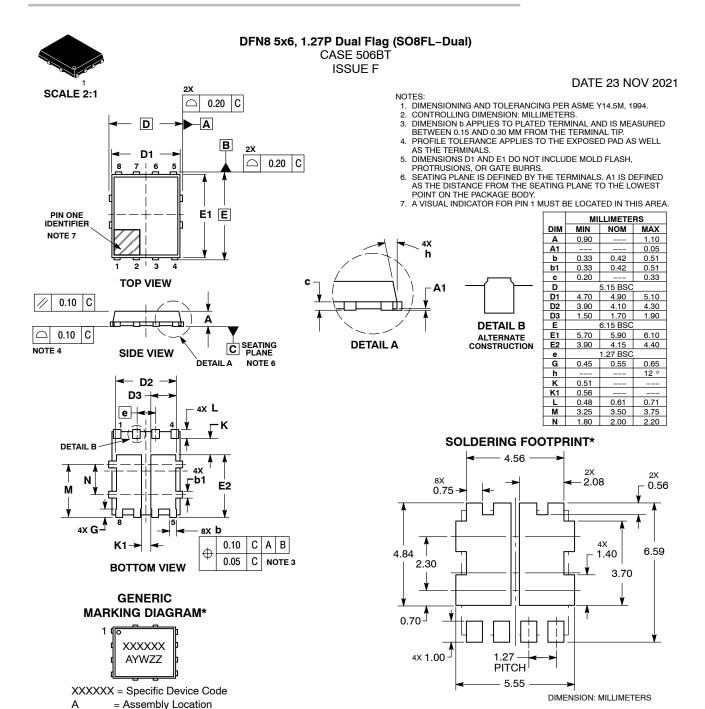
Figure 13. Thermal Characteristics

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NVMFD5C478NT1G	5C478N	DFN8 (Pb-Free)	1500 / Tape & Reel
NVMFD5C478NWFT1G	478NWF	DFN8 (Pb-Free)	1500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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= Year

not follow the Generic Marking.

= Work Week

= Lot Traceability \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may

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\*For additional information on our Pb-Free strategy and soldering

Mounting Techniques Reference Manual, SOLDERRM/D.

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